

FORM	FORM PTO - 1449				ATTY DOCKET NO.: ASC-023DVC2					
		AL INFORMA	TION		APPLICA	NT:	Fit	zgerald		
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	····		U.S.	PATENT	DOCUM	ENTS				. ".
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME			CLASS	SUB CLASS	1	ING DATE IF
Le	A117	5,424,243	06/13/1995	Takasaki						
1	A118	2002/0052084	05/02/2002	Fitzgeralo	ı			 	05/1	6/2001
	A119	2003/0077867	04/24/2003	Fitzgerald]		-		07/1	6/2001
DL	A120	6,602,613	08/05/2003	Fitzgeralo	i				01/1	7/2001
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			OTHER AR	T, JOUR	NAL ART	ICLES, E	ETC.			
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Her	Al	4,010,045	03/01/1977	Ruehrwein		 	
1	A2	4,710,788	12/01/1987	Dambkes et al.			
	A3	4,987,462	01/22/1991	Kim et al.			
	A4	4,990,979	02/05/1991	Otto	1		
	A5	5,013,681	05/07/1991	Godbey et al.	 	 	
	A6	5,155,571	10/13/1992	Wang et al.	1	ļ	1
	A7	5,166,084	11/24/1992	Pfiester			
1	A8	5,202,284	04/01/1993	Kamins et al.		 	1
	A9	5,207,864	05/04/1993	Bhat et al.	 	 -	
	A10	5,208,182	05/04/1993	Narayan et al.	<u> </u>		
	All	5,212,110	05/18/1993	Pfiester et al.			
	A12	5,221,413	06/22/1993	Brasen et al.	 		
	A13	5,241,197	08/31/1993	Murakami et al.		<u> </u>	
_	A14	5,285,086	02/08/1994	Fitzgerald, Jr.	 		
	A15	5,291,439	03/01/1994	Kauffmann, et al.	1.		
	A16	5,310,451	05/10/1994	Tejwani et al.			
	A17	5,316,958	05/31/1994	Meyerson			
	A18	5,346,848	09/13/1994	Grupen-Shemansky et al.			
	A19	5,374,564	12/20/1994	Bruel		 	
	A20	5,413,679	05/09/1995	Godbey			· · · · · · · · · · · · · · · · · · ·
	A21	5,426,069	06/20/1995	Selvakumar et al.	 		
	A22	5,426,316	06/20/1995	Mohammad		 	
	A23	5,461,243	10/24/1995	Ek et al.		 	
	A24	5,461,250	10/24/1995	Burghartz et al.			
	A25	5,462,883	10/31/1995	Dennard et al.	1	 	
-+	A26	5,476,813	12/19/1995	Naruse	 	 	
-+	A27	5,479,033	12/26/1995	Baca et al.	 	 	
	A28	5,484,664	01/16/1996	Kitahara et al.		 	
$-\pm$	A29	5,523,243	06/04/1996	Mohammad	 	 	
JII	A30	5,523,592	06/04/1996	Nakagawa et al.	+	 	

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Xalla	A31	5,536,361	07/16/1996	Kondo et al.			
10	A32	5,540,785	07/30/1996	Dennard et al.			
	A33	5,596,527	01/12/1997	Tomioka, et al.			
-	A34	5,617,351	04/01/1997	Bertin, et al.		 	
	A35	5,683,934	11/04/1997	Candelaria			
-+	A36	5,698,869	12/16/1997	Yoshimi et al.		 	
-	A37	5,728,623	03/17/1998	Mori			
	A38	5,739,567	04/14/1998	Wong			
 	A39	5,759,898	06/02/1998	Ek et al.		-	
-	A40	5,777,347	07/07/1998	Bartelink			
	A41	5,786,612	07/28/1998	Otani et al.			
	A42	5,786,614	07/28/1998	Chuang, et al.			
	A43	5,792,679	08/11/1998	Nakato		1	
	A44	5,808,344	09/15/1998	Ismail et al.			
+	A45	5,847,419	12/08/1998	Imai et al.			
	A46	5,877,070	03/02/1999	Goesele et al.			
_	A47	5,906,708	05/25/1999	Robinson et al.			
	A48	5,912,479	06/15/1999	Mori et al.			
_	A49	5,943,560	08/24/1999	Chang et al.			
_	A50	5,963,817	10/05/1999	Chu et al.			
	A51	5,966,622	10/12/1999	Levine et al.			
	A52	5,998,807	12/07/1999	Lustig et al.			
	A53	6,013,134	01/11/2000	Chu et al.			
	A54	6,033,974	03/07/2000	Henley et al.			
+	A55	6,033,995	03/07/2000	Muller	,		
_	A56	6,058,044	05/02/2000	Sugiura et al.			
_	A57	6,074,919	06/13/2000	Gardner et al.			
$\neg \uparrow \neg$	A58	6,096,590	08/01/2000	Chan et al.			
	A59	6,103,559	08/15/2000	Gardner et al.			
(D) 1 -	A60	6,111,267	08/29/2000	Fischer et al.			

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Sh	A61	6,117,750	09/12/2000	Bensahel et al.			
<i>y</i>	A62	6,130,453	10/10/2000	Mei, et al.		 	
	A63	6,133,799	10/17/2000	Favors, Jr., et al.		 	
	A64	6,140,687	10/31/2000	Shimomura et al.			
	A65	6,143,636	11/07/2000	Forbes, et al.			
	A66	6,153,495	11/28/2000	Kub et al.		-	
	A67	6,154,475	11/28/2000	Soref et al.		 	
	A68	6,160,303	12/12/2000	Fattaruso		 	
	A69	6,162,688	12/19/2000	Gardner et al.			
	A70	6,184,111	02/06/2001	Henley et al.			
	A71	6,191,007	02/20/2001	Matsui et al.			
	A72	6,191,432	02/20/2001	Sugiyama et al.			
1	A73	6,194,722	02/27/2001	Fiorini et al.			
	A74	6,204,529	03/20/2001	Lung, et al.	-		
	A75	6,207,977	03/01/2001	Augusto			
	A76	6,210,988	04/03/2001	Howe et al.		 	
	A77	6,218,677	04/17/2001	Broekaert		 	
	A78	6,232,138	05/15/2001	Fitzgerald et al.		·	
	A79	6,235,567	05/22/2001	Huang			
1	A80	6,242,324	06/05/2001	Kub et al.		 _	
	A81	6,249,022	06/19/2001	Lin, et al.		<u> </u>	
	A82	6,251,755	06/26/2001	Furukawa et al.	-		
	A83	6,261,929	07/01/2001	Gehrke et al.			
	A84	6,266,278	07/24/2001	Harari, et al.			
1	A85	6,271,551	08/07/2001	Schmitz et al.		 	
<u> </u>	A86	6,271,726	08/07/2001	Fransis et al.		 	
1	A87	6,313,016	11/06/2001	Kibbel et al.		 	
	A88	6,316,301	11/13/2001	Kant		<u> </u>	
.17	A89	6,323,108	11/27/2001	Kub et al.	- 	 	
(N) 1	A90	6,329,063	12/11/2001	Lo et al.		<u> </u>	

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Alu	A91	6,335,546	01/01/2002	Tsuda et al.			07/30/1999
1	A92	6,339,232	01/15/2002	Takagi			09/20/1999
	A93	6,368,733	04/09/2002	Nishinaga			08/05/1999
	A94	6,372,356	04/16/2002	Thornton et al.			04/028/2000
	A95	6,399,970	06/04/2002	Kubo et al.			09/16/1997
	A96	6,407,406	06/18/2002	Tezuka			06/29/1999
	A97	6,425,951	07/30/2002	Chu et al.			08/06/1999
	A98	6,429,061	08/06/2002	Rim			07/26/2000
	A99	6,420,937	07/16/2002	Akatsuka et al.			06/14/2001
	A100	6,521,041	02/18/2003	Wu et al.			04/09/1999
	A101	6,555,839	04/29/2003	Fitzgerald			05/16/2001
-	A102	6,583,015	06/24/2003	Fitzgerald et al.			08/06/2001
	A103	6,521,041	02/18/2003	Wu et al.			04/09/1999
	A104	2001/0003364	06/14/2001	Sugawara et al.			12/08/2000
	A105	2002/0043660	04/18/2002	Yamazaki et al.		<u> </u>	06/25/2001
	A106	6,593,191	07/15/2003	Fitzgerald		 	05/16/2001
	A107	6,573,126	06/03/2003	Cheng et al.		 	08/10/2001
	A108	2002/0096717	07/25/2002	Chu et al.			01/25/2001
	A109	2002/0100942	08/01/2001	Fitzgerald et al.			06/19/2001
	A110	2002/0123167	09/05/2002	Fitzgerald		<u> </u>	07/16/2001
	A111	2002/0123183	09/05/2002	Fitzgerald			07/16/2001
	A112	2002/0123197	09/05/2002	Fitzgerald et al.		1	06/19/2001
	A113	2002/0125471	09/12/2002	Fitzgerald et al.			12/04/2001
	A114	2002/0125497	09/12/2002	Fitzgerald		-	07/16/2001
	A115	6,603,156	08/05/2003	Rim		 	03/31/2001
Q,	A116	2003/0003679	01/02/2003	Doyle et al.		 	06/29/2001

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Q)	BI	41 01 167	07/23/1992	DE		 		NO	NO
1	B2	0 587 520	03/16/1994	EP				NO	YES
	В3	0 683 522	11/22/1995	EP				NO	YES
1	B4	0 828 296	03/11/1998	EP				NO	YES
	B5	0 829 908	03/18/1998	EP		-		NO	YES
\top	В6	0 838 858	04/29/1998	EP				NO	NO
\dashv	В7	1 020 900	07/19/2000	EP				NO	YES
1	B8	1 174 928	01/23/2002	EP		<u> </u>		NO	YES .
7	В9	2 342 777	04/19/2000	GB		<u> </u>		YES	YES
\top	B10	10-270685	10/09/1998	JP				NO	YES
1	B11	11-233744	08/27/1999	JP				NO	NO
\neg	B12	2000-021783	08/31/2000	JP		·		NO	YES
	B13	2000-031491	01/28/2000	JP				NO	NO
	B14	2001-319935	11/16/2001	JP		1		NO	YES
	B15	2002-076334	03/15/2002	JP				NO	YES
	B16	2002-164520	06/07/2002	JP				NO	YES
	B17	2002-289533	10/04/2002	JР				NO	YES
\neg	B18	4-307974	10/30/1992	JP				NO	NO
1	B19	5-166724	07/02/1993	JP				NO	Abstract Onl
1	B20	6-177046	06/24/1994	JP		1		NO	Abstract Onl
	B21	7-106446	04/21/1995	JР		 		NO	NO
	B22	7-240372	09/12/1995	JP	<u> </u>	†		NO	Abstract Onl
. 1	B23	00/48239	08/17/2000	wo		 		NO	YES
أهمأ	0_ B24	00/54338	09/14/2000	wo	 	\vdash		NO	YES

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De	B25	01/022482	03/29/2001	wo				NO	YES
- (, -	B26	01/54202	07/26/2001	wo		<u> </u>	-	NO	YES
	B27	01/93338	12/06/2001	wo		1		NO	YES
1	B28	01/99169	12/27/2001	wo			 	NO	YES
	B29	02/071488	09/12/2002	wo				NO	YES
	B30	02/071491	09/12/2002	wo	 	<u> </u>		NO	YES
	B31	02/071495	09/12/2002	wo	 	1	<u> </u>	NO	YES
	B32	02/082514	10/17/2002	wo	1	1	 	NO	YES
	B33	02/13262	02/14/2002	wo	 		 	NO	YES
1	B34	02/15244	02/21/2002	wo	 			NO	YES
 	B35	02/27783	04/04/2002	wo			 	NO	YES
	B36	02/47168	06/13/2002	wo -				NO	YES
1	B37	98/59365	12/30/1998	wo		 		NO	YES
1	B38	99/53539	10/21/1999	wo		<u>.</u>	<u> </u>	NO	YES
WI	B39	6-252046	11/19/1992	JP		<u> </u>	<u> </u>	NO	YES

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			FILING DATE:	December 17, 2001				
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		OTHER ART, JOUR	NAL ARTICLES, ET	c.				
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Sh	C1	Armstrong et al., "Design of Si/SiGe Het Transistors," IEDM Technical Digest (19						
	C2	Armstrong, "Technology for SiGe Hetero Massachusetts Institute of Technology, 1	ostructure-Based CMOS De 999, pp. 1-154.	evices", PhD Thesis,				
	C3		Augusto et al., "Proposal for a New Process Flow for the Fabrication of Silicon-based Complementar MOD-MOSFETs without ion Implantation," Thin Solid Films, vol. 294, no. 1-2, pp. 254-258 (February 15, 1997).					
	C4	Barradas et al., "RBS analysis of MBE-g content SiGe channels for HMOS transis						
·	C5		Borenstein et al., "A New Ultra-Hard Etch-Stop Layer for High Precision Micromachining," Proceedings of the 1999 12th IEEE International Conference on Micro Electro Mechanical Systems (MEMs) (January 17-21, 1999) pp. 205-210.					
	C6	Bouillon et al., "Search for the optimal cl Experimental study," IEEE, (1996) pp. 2	hannel architecture for 0.18 1.2.1-21.2.4.	3/0.12 μm bulk CMOS				
	C7	Bruel et al., "@SMART CUT: A Promis International SOI Conference (October 1		hnology," Proceedings 1995 IEEE				
	C8	Bruel, "Silicon on Insulator Material Tec pp. 1201-1202.	hnology," Electronic Lette	rs, Vol. 13, No. 14 (July 6, 1995)				
	C9	Bufler et al., "Hole transport in strained S Physics, Vol. 84, No. 10 (November 15,		ey substrates," Journal of Applied				
	C10	Burghartz et al., "Microwave Inductors a Technology", IEEE Transactions on Mic 1996, pp. 100-104.						
	C11	Canaperi et al., "Preparation of a relaxed Si-Ge layer on an insulator in fabricating high-speed semiconductor devices with strained epitaxial films," International Business Machines Corporation USA (2002) (abstract).						
	C12	Carlin et al., "High Efficiency GaAs-on-Si Solar Cells with High Voc Using Graded GeSi Buffers," IEEE (2000) pp. 1006-1011						
	C13	Chang et al., "Selective Etching of SiGe/No. 1 (January 1991) pp. 202-204.	Si Heterostructures," Journ	al of the Electrochemical Society,				
U	C14	Cheng et al., "Electron Mobility Enhance Insulator (SGOI) Substrates," IEEE Elec						
De	C15	Cheng et al., "Relaxed Silicon-Germaniu Electronic Materials, Vol. 30, No. 12 (20		y Layer Transfer," Journal of				

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		OTHER ART, JOURNAL ARTICLES, ETC.									
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Kh	C16	Cullis et al, "Growth ripples upon strained SiGe epitaxial layers on Si and misfit dislocation interactions," Journal of Vacuum Science and Technology A, Vol. 12, No. 4 (July/August 1994) pp. 1924-1931.									
1	C17	Currie et al., "Carrier mobilities and process stability of strained S in- and p-MOSFETs on SiGe virtual substrates," J. Vac. Sci. Technol. B., Vol. 19, No. 6 (Nov/Dec 2001) pp. 2268-2279.									
	C18	Eaglesham et al., "Dislocation-Free Stranski-Krastanow Growth of Ge on Si(100)," Physical Review Letters, Vol. 64, No. 16 (April 16, 1990) pp. 1943-1946.									
	C19	Feijoo et al., "Epitaxial Si-Ge Etch Stop Layers with Ethylene Diamine Pyrocatechol for Bonded and Etchback Silicon-on-Insulator," Journal of Electronic Materials, Vol. 23, No. 6 (June 1994) pp. 493-496.									
	C20	Fischetti et al., "Band structure, deformation potentials, and carrier mobility in strained Si, Ge, and SiGe alloys," J. Appl. Phys., Vol. 80, No. 4 (August 15, 1996) pp. 2234-2252.									
	C21	Fischetti, "Long-range Coulomb interactions in small Si devices. Part II. Effective electronmobility i thin-oxide structures," Journal of Applied Physics, Vol. 89, No. 2 (January 15, 2001) pp. 1232-1250.									
	C22	Fitzgerald et al., "Dislocation dynamics in relaxed graded composition semiconductors," Materials Science and Engineering B67, (1999) pp. 53-61.									
	C23	Fitzgerald et al., "Relaxed GexSi1-x structures for III-V integration with Si and high mobility two- dimensional electron gases in Si," AT&T Bell Laboratories, Murray Hill, NJ 07974 (1992) American Vacuum Society, pp. 1807-1819									
	C24	Fitzgerald et al., "Totally Relaxed GexSi1-x Layers with Low Threading Dislocation Densities Grown on Si Substrates," Applied Physics Letters, Vol. 59, No. 7 (August 12, 1991) pp. 811-813.									
	C25	Garone et al., "Silicon vapor phase epitaxial growth catalysis by the presence of germane," Applied Physics Letters, Vol. 56, No. 13 (March 26, 1990) pp. 1275-1277.									
	C26	Gray and Meyer, "Analysis and Design of Analog Integrated Circuits", John Wiley & Sons, 1984, pp. 605-632.									
	C27	Grützmacher et al., "Ge segregation in SiGe/Si heterostructures and its dependence on deposition technique and growth atmosphere," Applied Physics Letters, Vol. 63, No. 18 (November 1, 1993) pp. 2531-2533.									
	C28	Hackbarth et al., "Alternatives to thick MBE-grown relaxed SiGe buffers," Thin Solid Films, Vol. 369, No. 1-2 (July 2000) pp. 148-151.									
	C29	Hackbarth et al., "Strain relieved SiGe buffers for Si-based heterostructure field-effect transistors," Journal of Crystal Growth, Vol. 201/202 (1999) pp. 734-738.									
	C30	Herzog et al., "SiGe-based FETs: buffer issues and device results," Thin Solid Films, Vol. 380 (2000 pp. 36-41.									
Rh	C31	Höck et al., "Carrier mobilities in modulation doped Si1-xGex heterostructures with respect to FET applications," Thin Solid Films, Vol. 336 (1998) pp. 141-144.									

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He	C32	Höck et al., "High hole mobility in Si0.17 Ge0.83 channel metal-oxide-semiconductor field-effect transistors grown by plasma-enhanced chemical vapor deposition," Applied Physics Letters, Volume 76, No. 26 (June 26, 2000) pp. 3920-3922.		
1	C33			
	C34	Huang et al., "High-quality strain-relaxed substrate," Applied Physics Letters, Vol.		
	C35			
	C36	IBM Technical Disclosure Bulletin, Vol. 35, No. 4B (September 1992), "2 Bit/Cell EEPROM Cell Using Band to Band Tunneling for Data Read-Out," pp. 136-140.		
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